

# PCN / EOL Notification

Product Change Notification	Number: CC070201	<b>Date:</b> January 17, 2007
Title: AT24C32A DIE SHRINI	Κ	
Product Identification: All Wafers, Packages, and Vol +85C): see Attachment A for a	•	ustrial Temperature Grade (-40C to ng.
Reason for Change:	☐Design ☐Manufacturing Location ☐	☐ Processing ☐ Logistics ☐ Quality/Reliability ☐ Material
Change Description:		
+85C). The new version device process for the current AT24C suffix of the part identifier for the Atmel has also optimized the conferred only in 1.8V (Vcc from In addition, to accommodate the ONLY be available in Pb-Free ULTRA THIN MINI-MAP package.	ce will be manufactured utilize 32A. A NEW part number whe shrink: AT24C32C.  clock frequency at lower Vcc AT24C32A operation of 400k 1.8V to 3.6V).  The growing movement toward (Green) / Halogen-Free pacages, will consist of NiPdAu	A in the Industrial Temperature (-40 to ing the .25u process versus the .35u vill be created by adding a "C" to the  The new AT24C32C will operate at the at 2.5V. The new device will be designed. The 8-SOIC, 8-TSSOP, and 8-Lead Finish, designated by "H" in the Fin lead finish, will be designated by "U"
in the catalogue part number.	, 3	
New physical part marking s	scheme:	
8-Ultra Thin Mini M	<u>AP</u>	
TOP MARK		
	Y = YEAR	OF ASSEMBLY
 3 2 C     H 1	NSEB TRA	EL LOT NUMBER TO COORESPOND WITH  CE CODE LOG BOOK.  E = AA, AB, AC,AX, AY, AZ)
Y X X       *    Pin 1 Indicator (Dot)	7: 2007	YEAR 0: 2010 1: 2011 2: 2012

9: 2009 3: 2013

in Marking

## 8-SOIC

TOP MARK Seal Year	Y = SEAL YEAR WW = SEAL WEEK
Seal Week	6: 2006 0: 2010 02 = Week 2
	7: 2007 1: 2011 04 = Week 4
	8: 2008 2: 2012 :: : :::: :
A T M L H Y W W	9: 2009 3: 2013 :: : :::: ::
	50 = Week 50
3 2 C 1	52 = Week 52
* Lot Number	Lot Number to Use ALL Characters in
	BOTTOM MARK
Pin 1 Indicator (Dot)	No Bottom Mark

## 8-TSSOP

TOP MARK

```
Pin 1 Indicator (Dot)
 |---|---|
 * H Y W W
|---|---|
 3 2 C 1
|---|---|
```

Y =	SEAL	YEAR		WW = SEAL WEEK
6:	2006	0:	2010	02 = Week 2
7:	2007	1:	2011	04 = Week 4
8:	2008	2:	2012	:: : :::: :
9:	2009	3:	2013	:: : :::: ::
				50 = Week 50
				52 = Week 52

#### BOTTOM MARK

#### 8-PDIP

MARK	Seal Year	Y =	SEAL	YEAR		WW = SEAL WEEK
	Seal Week	6:	2006	0:	2010	02 = Week 2
		7:	2007	1:	2011	04 = Week 4
		8:	2008	2:	2012	:: : :::: :
A T M L U	Y W W	9:	2009	3:	2013	:: : :::: ::
						50 = Week 50
3 2 C 1						52 = Week 52
* Lot Number		Lot	Numbe	er to	Use ALL	Characters in Marking
		BOT	COM MA	ARK		
Pin 1 Indicator (Do	t)				No Bott	om Mark
	A T M L U    3 2 C 1    * Lot Number	Seal Week             A T M L U Y W W     3 2 C 1	Seal Week 6:	Seal Week 6: 2006         7: 2007      8: 2008 A T M L U Y W W 9: 2009     3 2 C 1      * Lot Number Lot Number	Seal Week 6: 2006 0:	Seal Week 6: 2006 0: 2010

### **Identification Method to Distinguish Change:**

Last Ship Date:

April 10, 2007

July 10, 2007

January 10, 2008

\*The Estimated Implementation Date is the forecasted date that a customer may expect to receive changed product. This is determined by the estimated date of inventory depletion on the PCN issue date. This may be affected by fluctuations in supply and demand. Consequently, although customers should be prepared to receive changed product on this date, Atmel will continue to ship pre-changed product until a time in which inventory has been depleted. This may result in ore-changed or product being shipped to customers after this forecasted date.

Atmel Contact: pcnadm@atmel.com

Atmel will deem this change accepted unless specific conditions of acceptance are provided in writing within 30 days from the date of this notice. All correspondence must be sent to the Quality Contact e-mail address listed above.

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## **Attachment A**

Current Part Number	Replacement Part Number
AT24C32A-10PU-1.8	AT24C32C-PU
AT24C32A-10PU-2.7	AT24C32C-PU
AT24C32A-10TU-1.8 BULK	AT24C32C-TH-B
AT24C32A-10TU-1.8 SL383 (T&R)	AT24C32C-TH-T (5k per reel)
AT24C32A-10TU-2.7 BULK	AT24C32C-TH-B
AT24C32A-10TU-2.7 SL383 (T&R)	AT24C32C-TH-T (5k per reel)
AT24C32A-W1.8-11	AT24C32C-W-11
AT24C32A-W1.8-27	AT24C32C-W-11
AT24C32A-W2.7-11	AT24C32C-W-11
AT24C32A-W2.7-7	AT24C32C-W-11
AT24C32A-WB1.8-11	AT24C32C-WU-11 (Green only)
AT24C32A-WU1.8-11	AT24C32C-WU-11
AT24C32AW-10SU-1.8 BULK	AT24C32CN-SH-B (Recommend JEDEC SOIC for replacement)
AT24C32AW-10SU-1.8 SL383 (T&R)	AT24C32CN-SH-T (Recommend JEDEC SOIC for replacement) (4k per reel)
AT24C32AW-10SU-2.7 BULK	AT24C32CN-SH-B (Recommend JEDEC SOIC for replacement)
AT24C32AW-10SU-2.7 SL383 (T&R)	AT24C32CN-SH-T (Recommend JEDEC SOIC for replacement) (4k per reel)
AT24C32AN-10SU-1.8 BULK	AT24C32CN-SH-B
AT24C32AN-10SU-1.8 SL383 (T&R)	AT24C32CN-SH-T (4k per reel)
AT24C32AN-10SU-2.7 BULK	AT24C32CN-SH-B
AT24C32AN-10SU-2.7 SL383 (T&R)	AT24C32CN-SH-T (4k per reel)
AT24C32AY1-10YU-1.8	AT24C32CY6-YH-T (5k per reel)
AT24C32AY1-10YU-2.7	AT24C32CY6-YH-T (5k per reel)
AT24C32AY6-10YH-1.8	AT24C32CY6-YH-T (5k per reel)